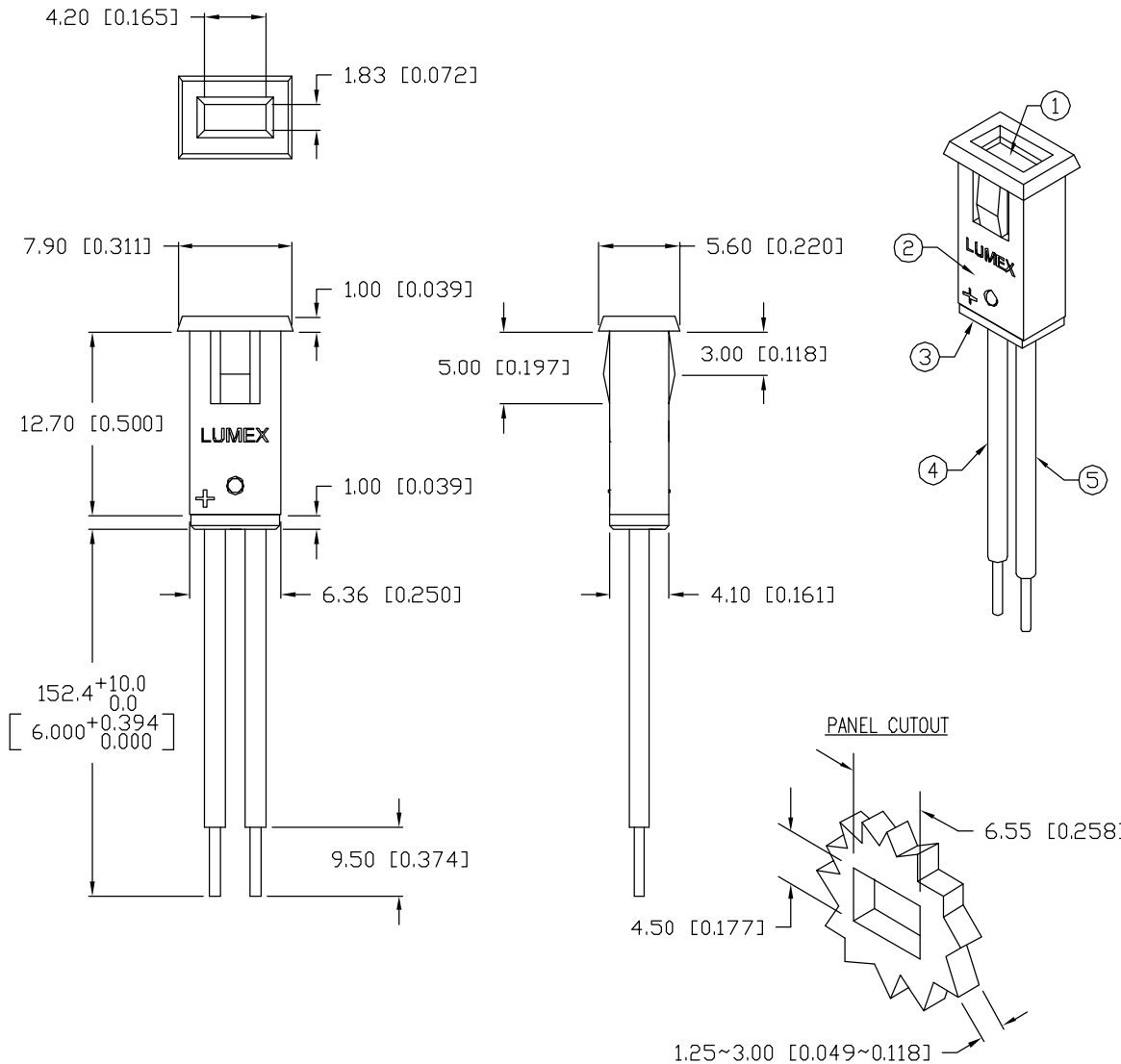


UNCONTROLLED DOCUMENT

PART NUMBER
SSI-LXMP059SRD-150

REV.
B

REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	E.C.N. #10122.	6.28.96
B	E.C.N. #10BRDR. & REDRAWN IN 3D.	1.7.02



ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		660		nm	
FORWARD VOLTAGE		1.7	2.2	V_f	
REVERSE VOLTAGE	4.0			V_r	$I_f=100\mu\text{A}$
AXIAL INTENSITY		25		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		110		2x theta	
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	RED DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	$\text{mW}/^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$

* $t < 10\mu\text{s}$

NOTES:

1. SSL-LX2573SRD, RED LED. TRIM LEADS TO 3~4mm LONG.
2. SSH-LXMP059-HSG, BLACK HOLDER.
3. SSH-LXMP059-BSG2, BUSHING.
4. ANODE LEAD: LXP-WST24RDTC, RED INSULATED, 24 AWG., CUT 155mm, STRIP 3mm & 9.5mm.
5. CATHODE LEAD: LXP-WST24BLTC, BLACK INSULATED, 24 AWG., CUT 155mm, STRIP 3mm & 9.5mm.
6. CRIMP OR SOLDER LEAD WIRES TO LED AND ASSEMBLE INTO HOUSING.

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN=+DECIMAL PRECISION MAX=+0.00 -DECIMAL PRECISION

UNCONTROLLED DOCUMENT

REV.
B

PART NUMBER
SSI-LXMP059SRD-150

CONFIDENTIAL INFORMATION
THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX INC., THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.



290 E. HELEN ROAD
PALATINE, IL 60067-6976
PHONE: +1.847.359.2790
US WEB: www.lumex.com
TW WEB: www.lumex.com.tw

660nm SUPER RED RECTANGULAR LED PANEL INDICATOR,
RED DIFFUSED LENS, 6" WIRE LEADS.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: BC	CHECKED BY:	APPROVED BY:	DATE: 6.28.95
			PAGE: 1 OF 1
			SCALE: N/A